

Project: STM32U5x9NJH6Q Discovery

Layer: **Top Overlay**

Gerber: .GTO

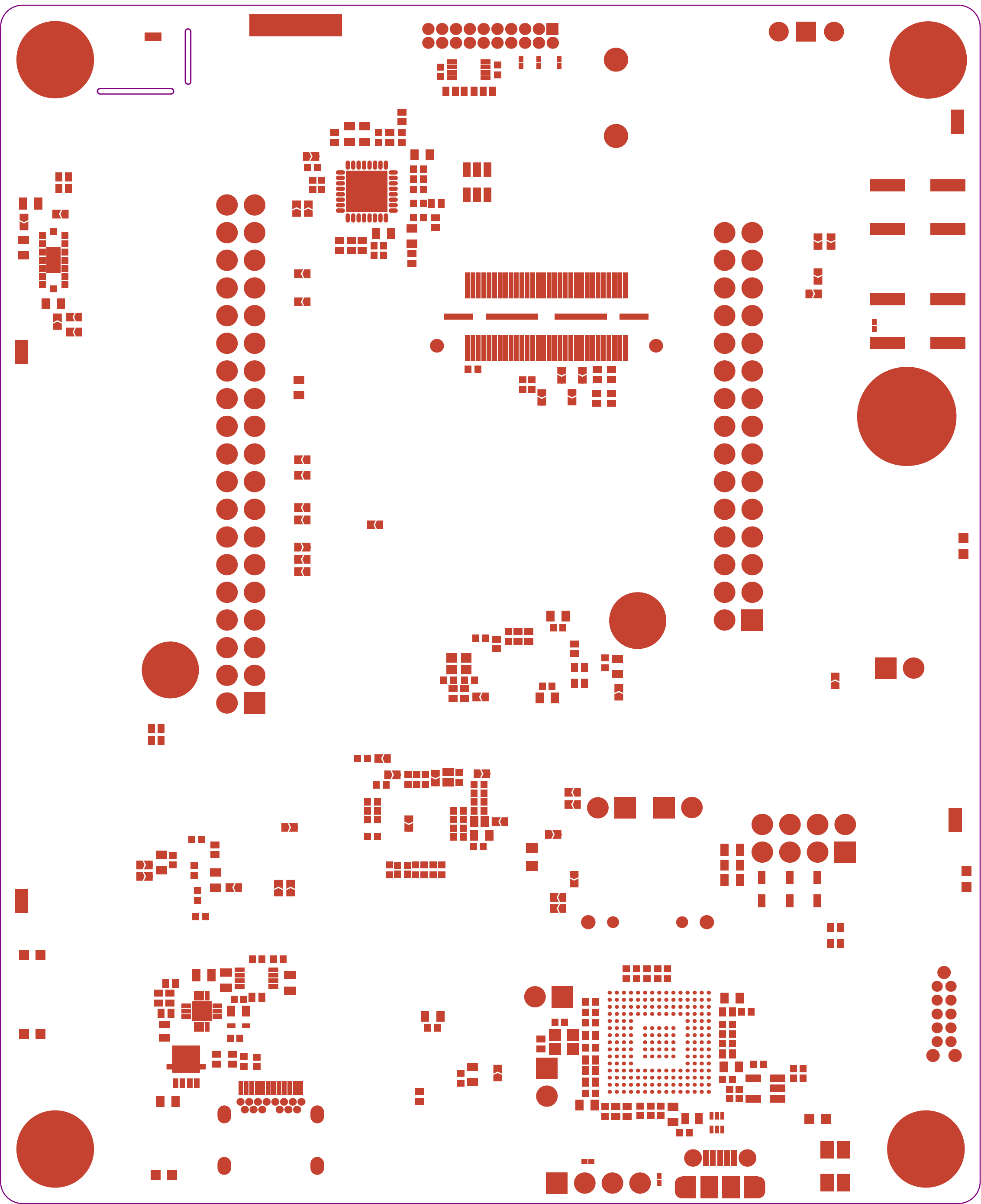
Variant: [No Variations]


Ref: MB1829

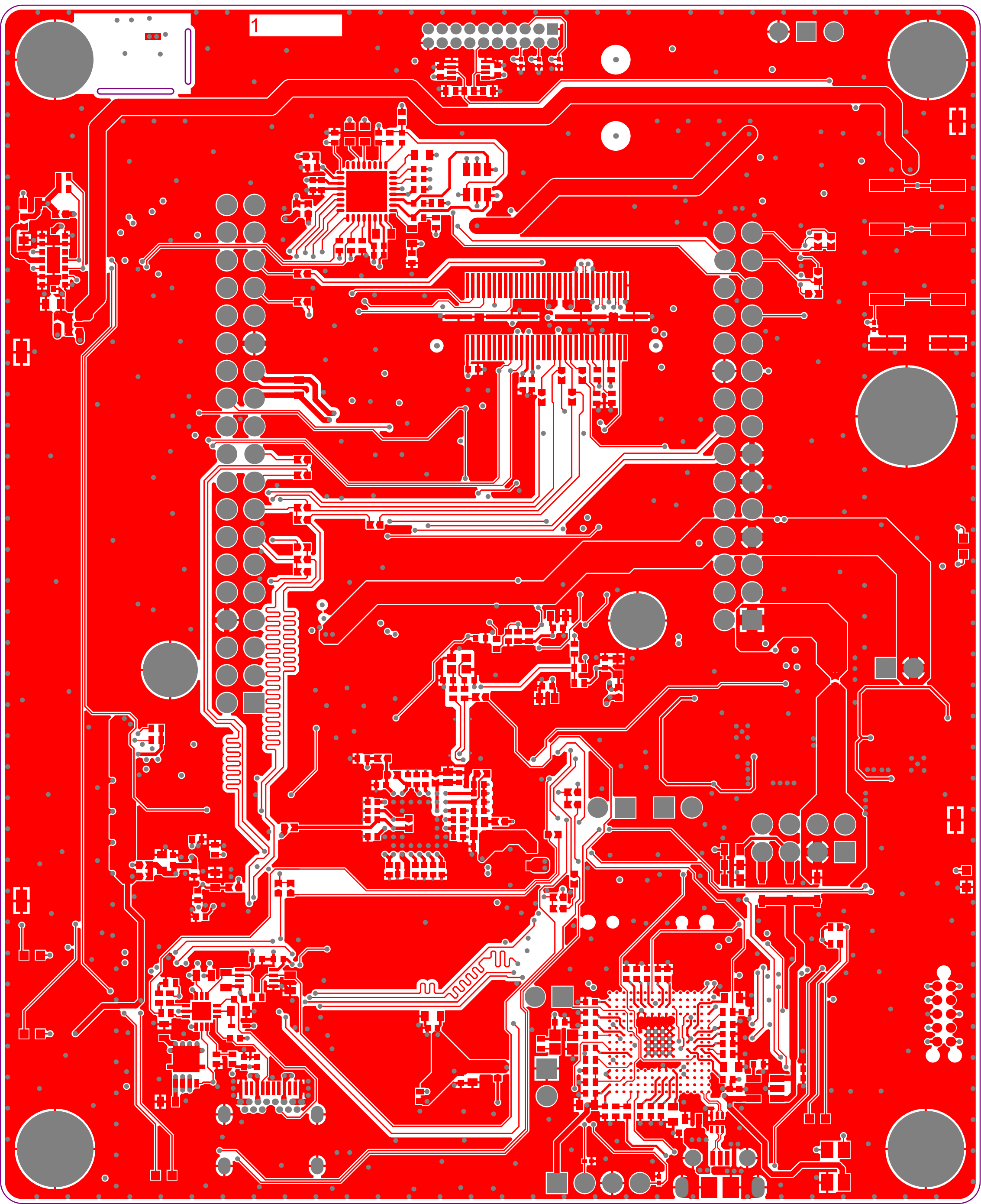
Date: 16-Mar-2023


Rev: B

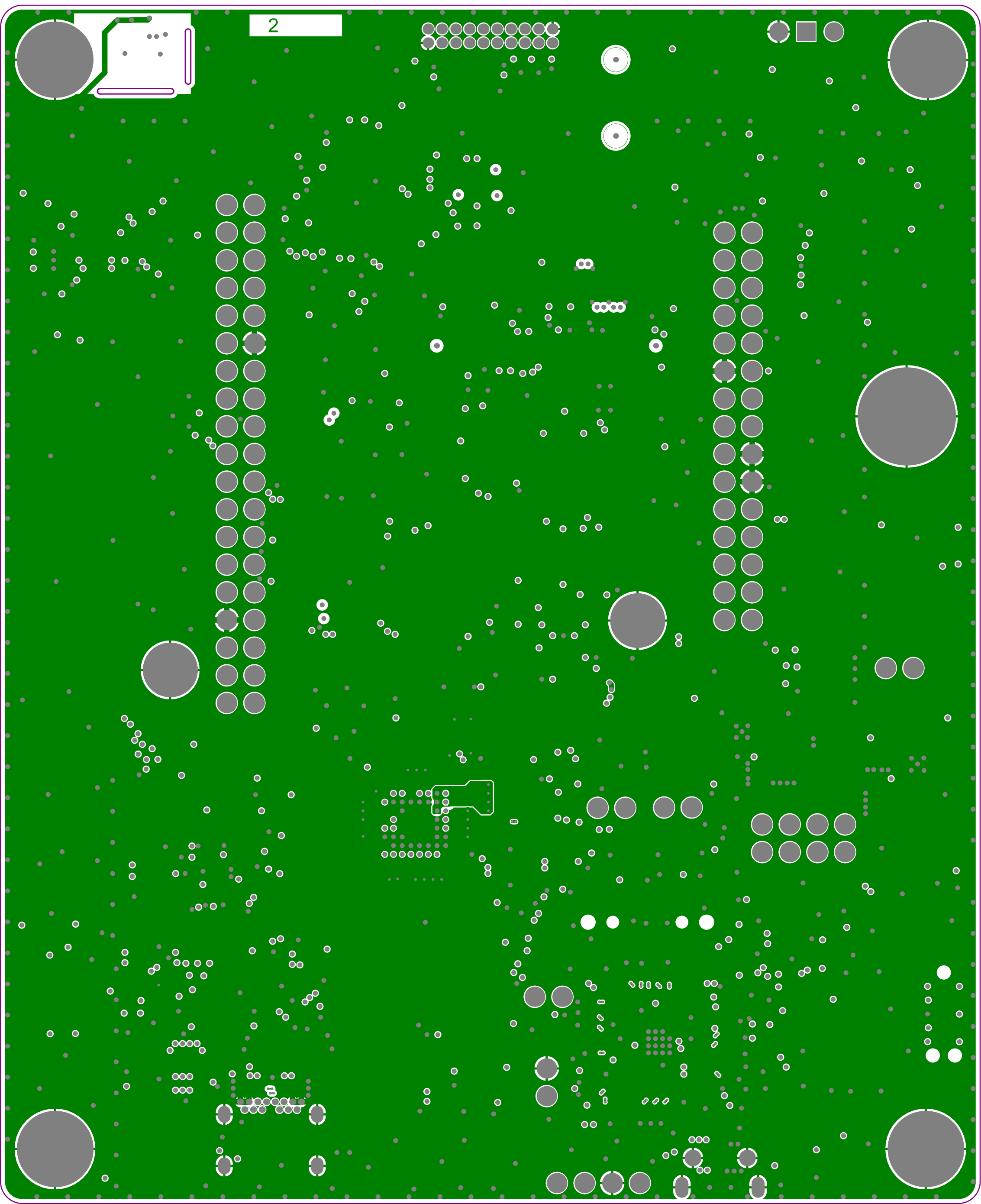





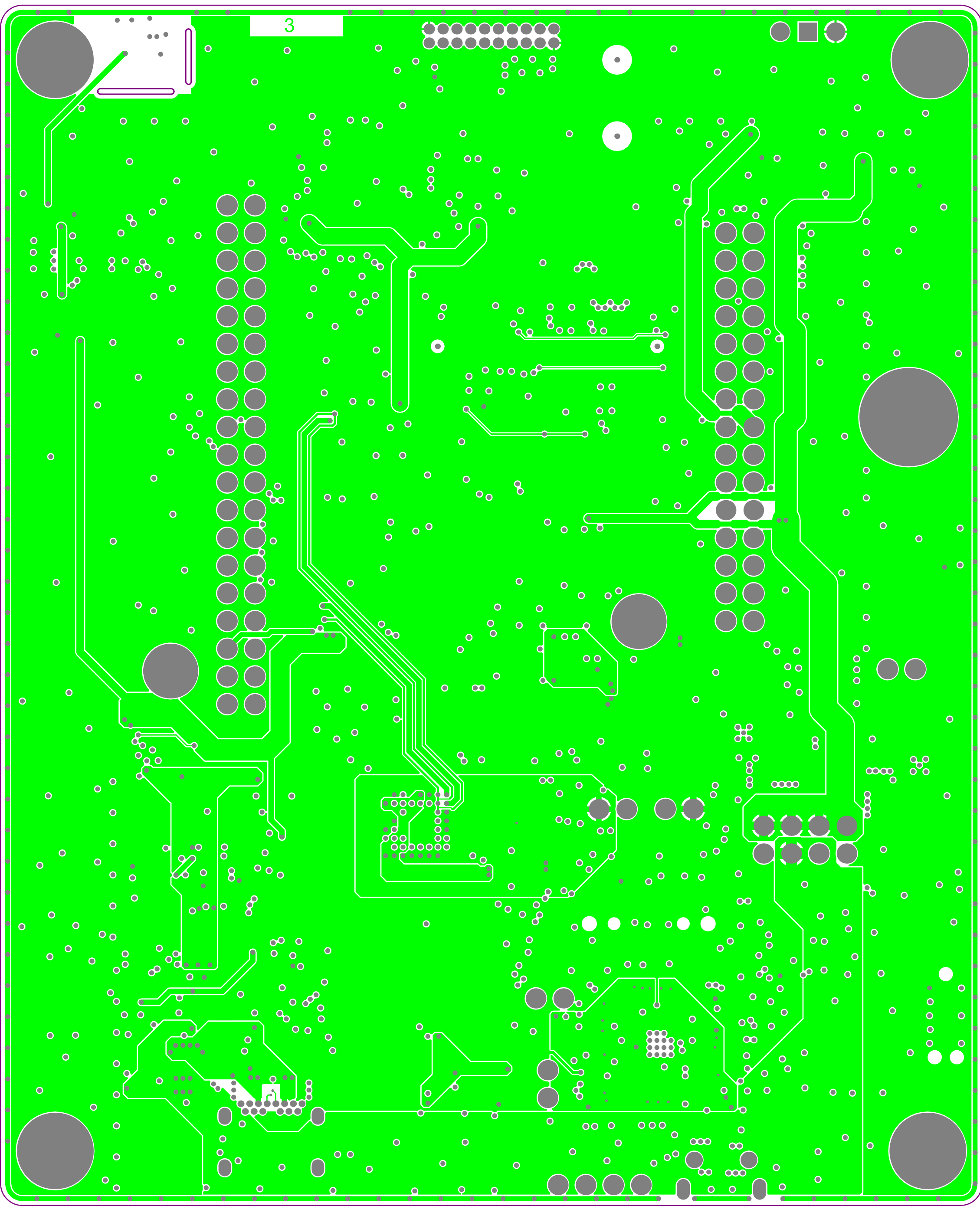
Project: STM32U5x9NJH6Q Discovery		
Layer: Top Solder	Gerber: .GTS	
Variant: [No Variations]	Ref: MB1829	
Date: 16-Mar-2023	Rev: B	




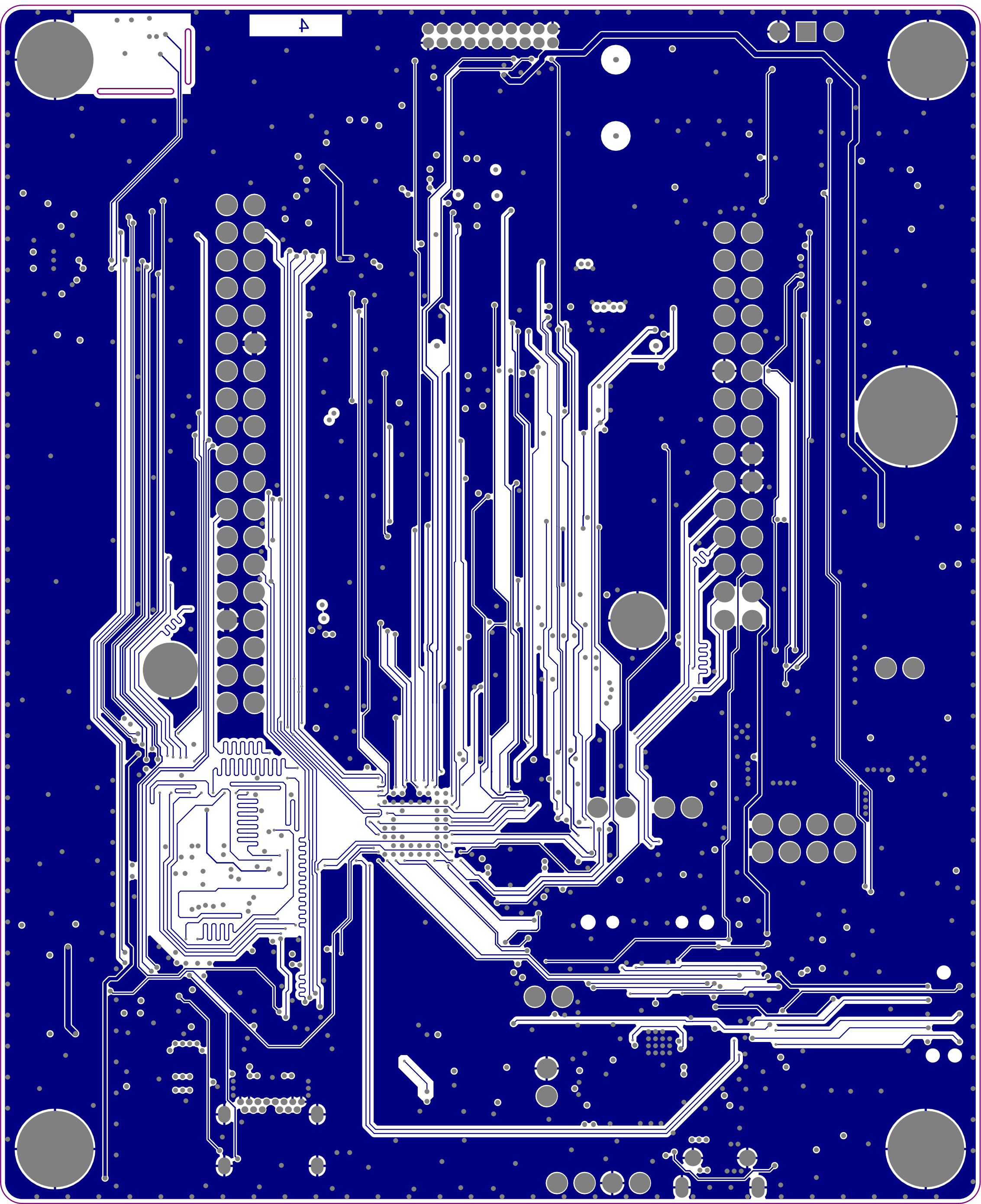
Project: STM32U5x9NJH6Q Discovery		
Layer: Top Layer	Gerber: .GTL	
Variant: [No Variations]	Ref: MB1829	
Date: 16-Mar-2023	Rev: B	




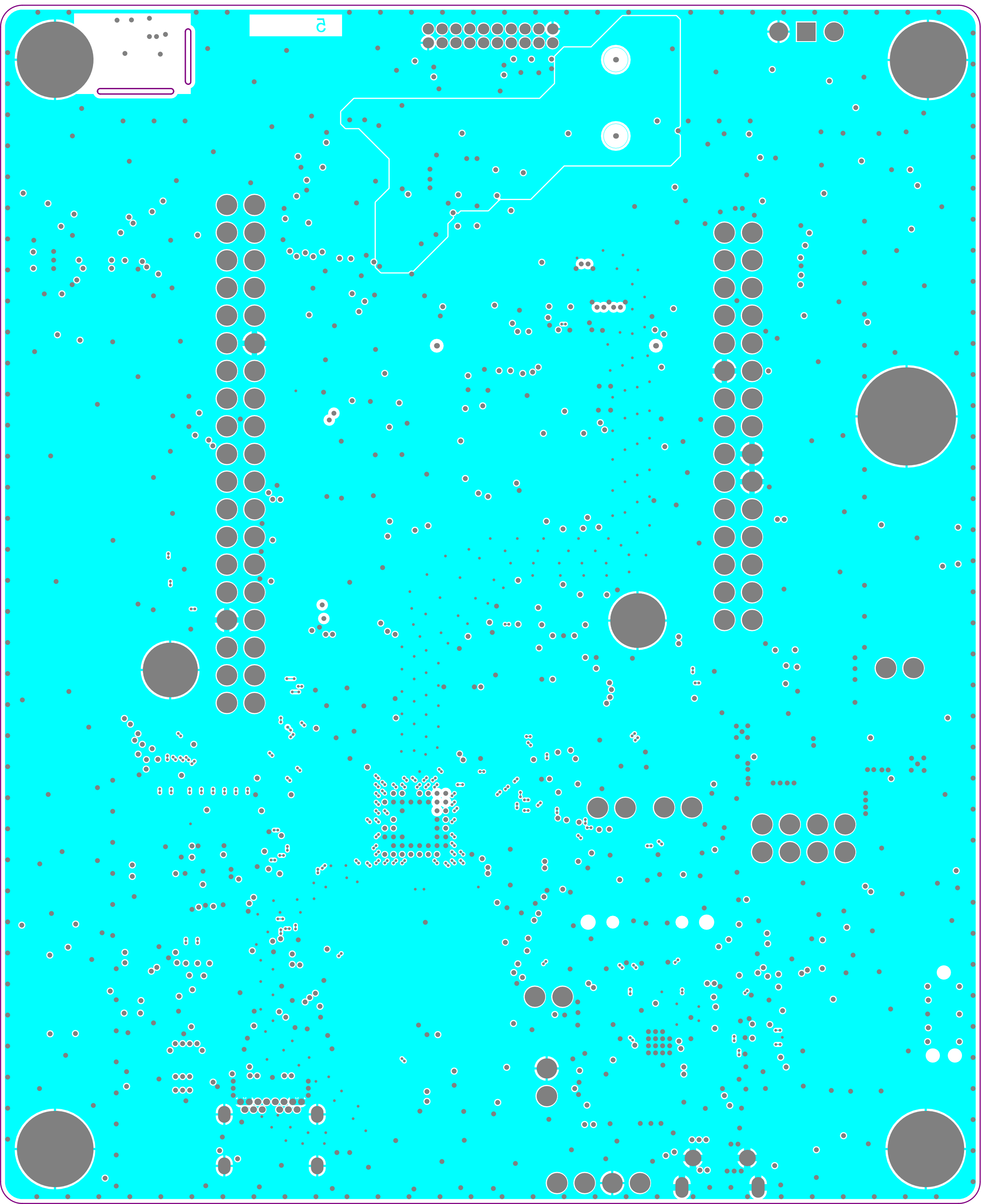
Project: STM32U5x9NJH6Q Discovery		
Layer: Signal Layer 1	Gerber: .G1	
Variant: [No Variations]	Ref: MB1829	
Date: 16-Mar-2023	Rev: B	




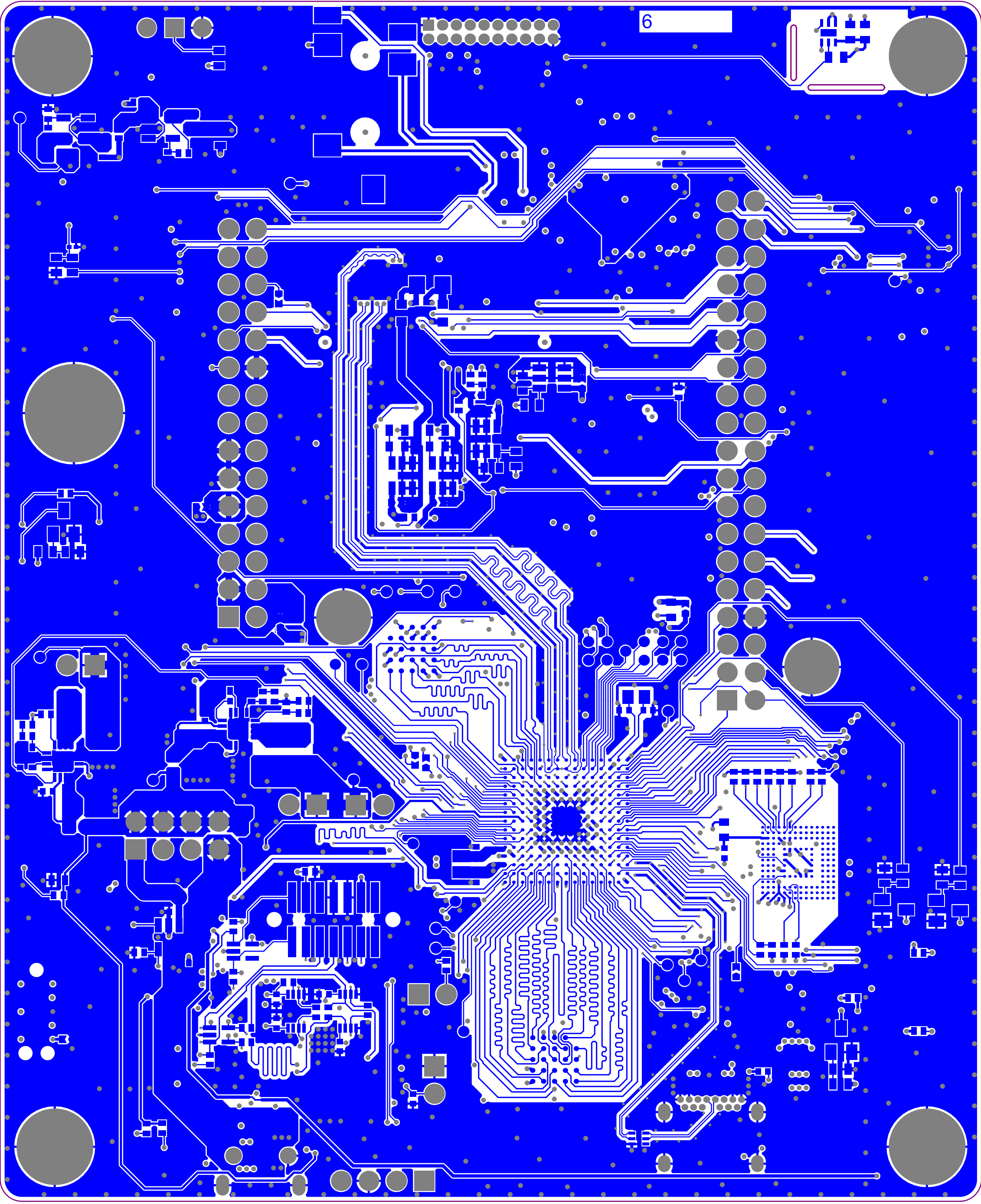
Project: STM32U5x9NJH6Q Discovery		
Layer: Signal Layer 2	Gerber: .G2	
Variant: [No Variations]	Ref: MB1829	
Date: 16-Mar-2023	Rev: B	




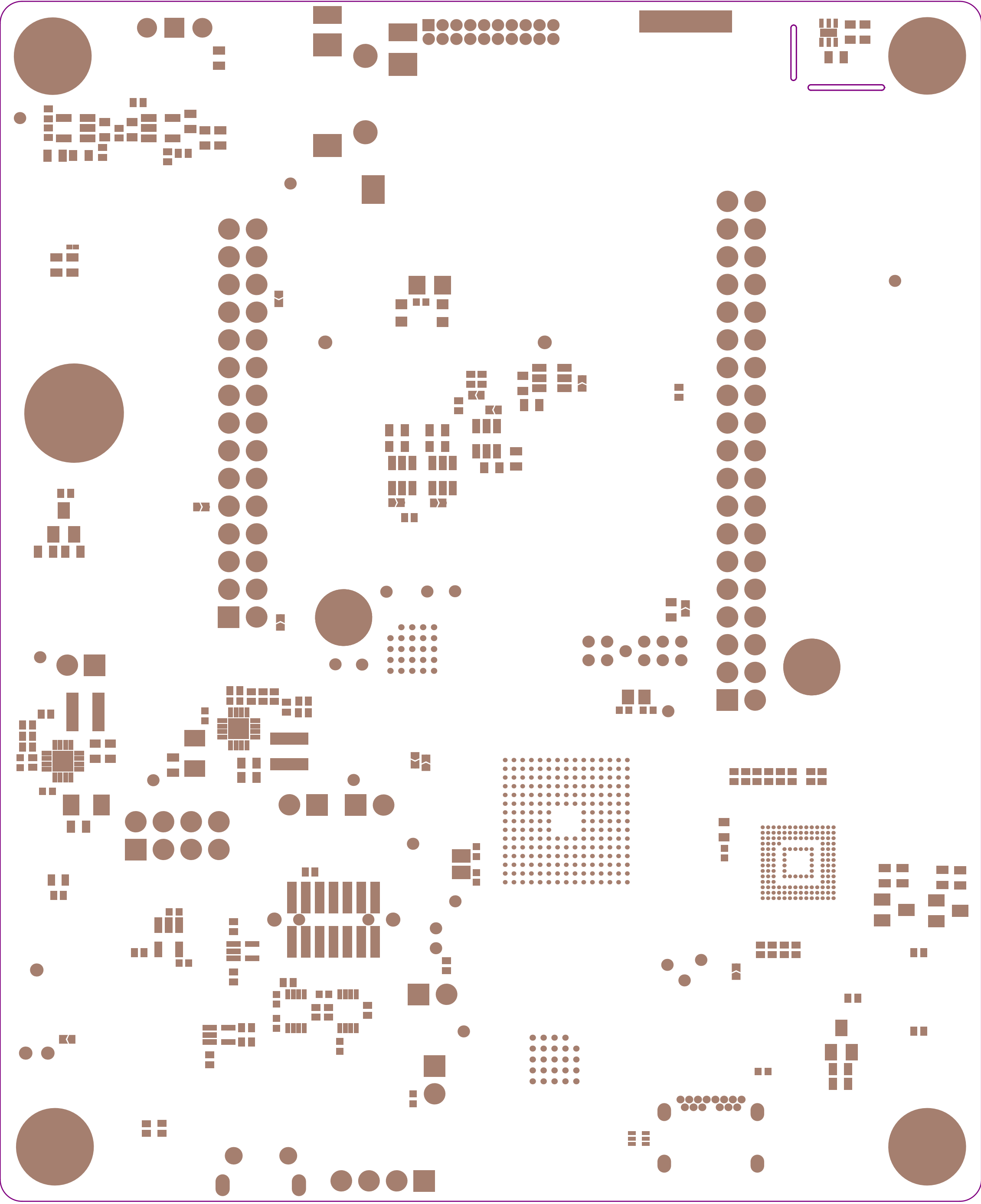
Project: STM32U5x9NJH6Q Discovery		
Layer: Signal Layer 3	Gerber: .G3	
Variant: [No Variations]	Ref: MB1829	
Date: 16-Mar-2023	Rev: B	




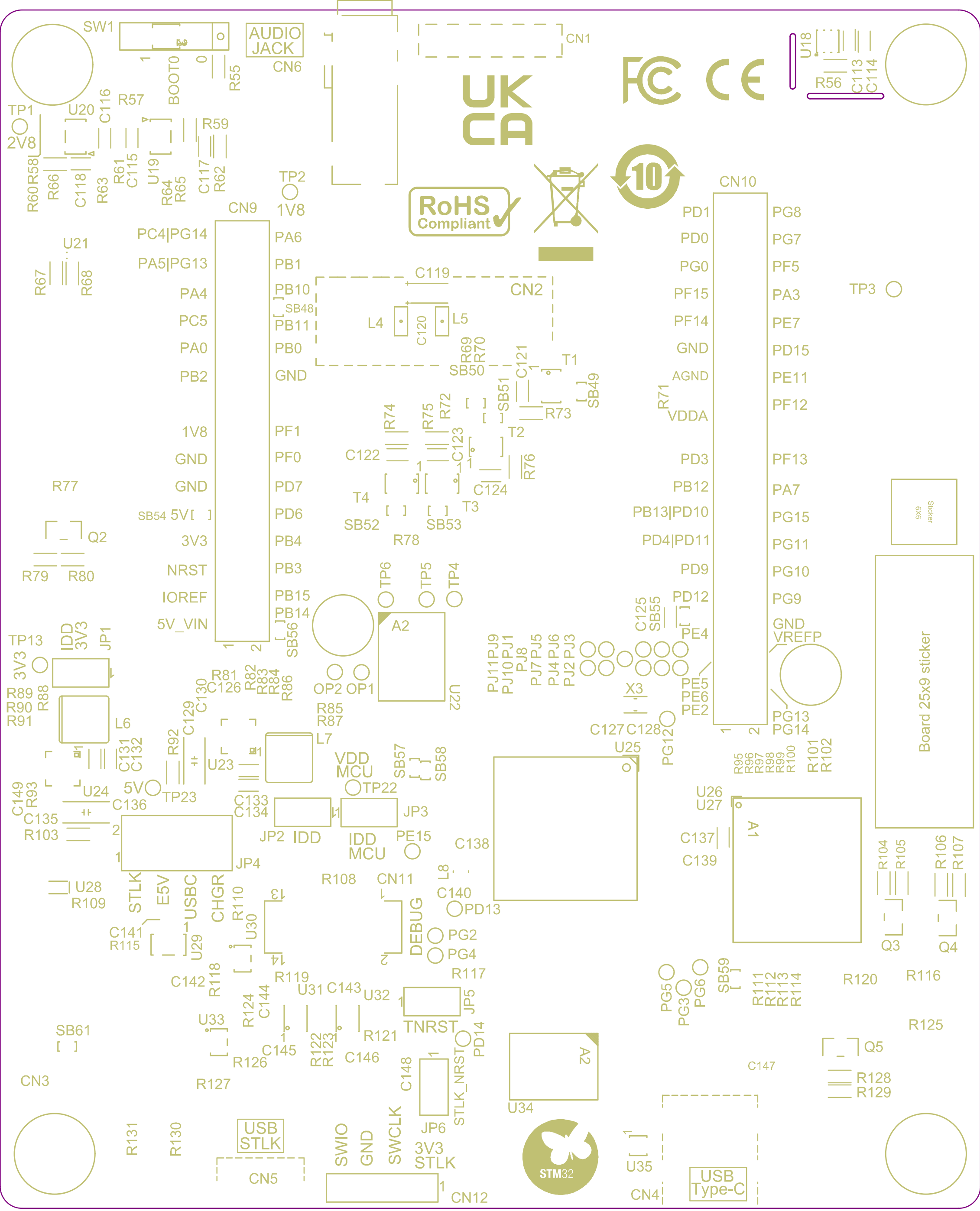
Project: STM32U5x9NJH6Q Discovery		
Layer: Signal Layer 4	Gerber: .G4	
Variant: [No Variations]	Ref: MB1829	
Date: 16-Mar-2023	Rev: B	




Project: STM32U5x9NJH6Q Discovery		
Layer: Bottom Layer	Gerber: .GBL	
Variant: [No Variations]	Ref: MB1829	
Date: 16-Mar-2023	Rev: B	



Project: STM32U5x9NJH6Q Discovery		
Layer: Bottom Solder	Gerber: .GBS	
Variant: [No Variations]	Ref: MB1829	
Date: 16-Mar-2023	Rev: B	



Project: STM32U5x9N Discovery		
Layer: Bottom Overlay	Gerber: .GBO	
Variant: [No Variations]	Ref: MB1829	
Date: 16-Mar-2023	Rev: B	

